

Invitation for Technical and Fee Proposals for Consultancy Agreements

Department

Civil Engineering and Development Department

Consultancy Agreement No.

CE 41/2024 (GE)

Agreement Title

Study of Groundwater, Sub-surface Moisture and Surface Drainage Water Associated with Man-made Slopes in Hong Kong with Field Instrumentation – Feasibility Study

Invitation Date

28/03/2025

Closing Date and Time

12:00 noon, Friday, 23 May 2025

Details of Consultancy

The scope of this consultancy, which is currently expected to commence in September 2025, is indicated in the draft Scope.

Contact Persons

Mr. Edward K. H. CHU (Senior Geotechnical Engineer/Slopes 2)
Planning and Development Division

Geotechnical Engineering Office
Civil Engineering and Development Department
Tel. No.: 2762 5355

Consultants Invited

Consultants in **Group 3** under the Service Category of Geotechnical and Slope (GE) maintained by EACSB are invited to submit Technical and Fee Proposals for undertaking the above consultancy.

Sole/Lead Consultants Invited:

Geotechnical and Slope (GE) – Group 3

1. AECOM Asia Company Limited
2. Asia Infrastructure Solutions Limited
3. Aurecon Hong Kong Limited
4. C M Wong & Associates Limited
5. Fugro (Hong Kong) Limited
6. Halcrow China Limited
7. Ove Arup & Partners Hong Kong Limited

Remarks

The electronic documents, referred to as the Electronic Invitation Package (EIP), are at Schedule 2 of the License Conditions for the EIP which can be downloaded from the e-Tendering System (Works Consultancy Services) ("**e-TS(CS)**") via this link <https://www.gov.hk/en/theme/etendering/ets/>. Interested consultants must register an account on the e-TS(CS) before downloading the EIP from the e-TS(CS).

Attention is drawn to bidding restrictions set out in the respective invitation letter issued to the above consultants and relevant sections of the Guidelines attached to DEVB TC(W) No. 5/2018 and its subsequent updates (if any).

Org Name: The Civil Engineering and Development Department

Country: Hong Kong